

Rectifier Diode

Avalanche Diode

V_{RRM} = 800-1800 V

I_{F(RMS)} = 160 A

I_{F(AV)M} = 110 A

V _{RSM}	V _{(BR)min} ①	V _{RRM}	Anode on stud	Cathode on stud
900	-	800	DS 75-08B	DSI 75-08B
1300	-	1200	DS 75-12B	DSI 75-12B
1300	1300	1200	DSA 75-12B	DSA 75-12B
1700	1760	1600	DSA 75-16B	DSA 75-16B
1900	1950	1800	DSA 75-18B	DSA 75-18B

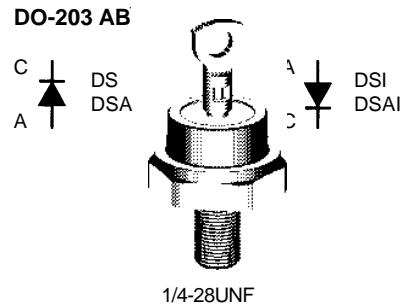
① Only for Avalanche Diodes

Symbol	Test Conditions	Maximum Ratings		
I _{F(RMS)}	T _{VJ} = T _{VJM}	160	A	
I _{F(AV)M}	T _{case} = 100°C; 180° sine	110	A	
P _{RSM}	DSA(I) types, T _{VJ} = T _{VJM} , t _p = 10 µs	20	kW	
I _{FSM}	T _{VJ} = 45°C; V _R = 0	1400 1500	A A	
	t = 10 ms (50 Hz), sine t = 8.3 ms (60 Hz), sine			
	T _{VJ} = T _{VJM} V _R = 0	1250 1310	A A	
	t = 10 ms (50 Hz), sine t = 8.3 ms (60 Hz), sine			
I ² t	T _{VJ} = 45°C V _R = 0	9800 9450	A ² s A ² s	
	t = 10 ms (50 Hz), sine t = 8.3 ms (60 Hz), sine			
	T _{VJ} = T _{VJM} V _R = 0	7820 7210	A ² s A ² s	
	t = 10 ms (50 Hz), sine t = 8.3 ms (60 Hz), sine			
T _{VJ}		-40...+180	°C	
T _{VJM}		180	°C	
T _{stg}		-40...+180	°C	
M _d	Mounting torque	2.4-4.5 21-40	Nm lb.in.	
Weight		21	g	

Symbol	Test Conditions	Characteristic Values		
I _R	T _{VJ} = T _{VJM} ; V _R = V _{RRM}	≤ 6	mA	
V _F	I _F = 150 A; T _{VJ} = 25°C	≤ 1.17	V	
V _{T0}	For power-loss calculations only	0.75	V	
r _T	T _{VJ} = T _{VJM}	2	mΩ	
R _{thJC}	DC current	0.5	K/W	
R _{thJH}	DC current	0.9	K/W	
d _s	Creepage distance on surface	4.05	mm	
d _A	Strike distance through air	3.9	mm	
a	Max. allowable acceleration	100	m/s ²	

Data according to IEC 60747
IXYS reserves the right to change limits, test conditions and dimensions

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1/4-28UNF

A = Anode C = Cathode

Features

- International standard package, JEDEC DO-203 AB (DO-5)
- Planar glassivated chips

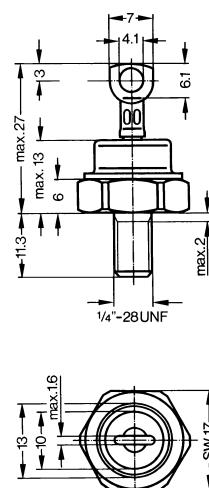
Applications

- High power rectifiers
- Field supply for DC motors
- Power supplies

Advantages

- Space and weight savings
- Simple mounting
- Improved temperature and power cycling
- Reduced protection circuits

Dimensions in mm (1 mm = 0.0394")



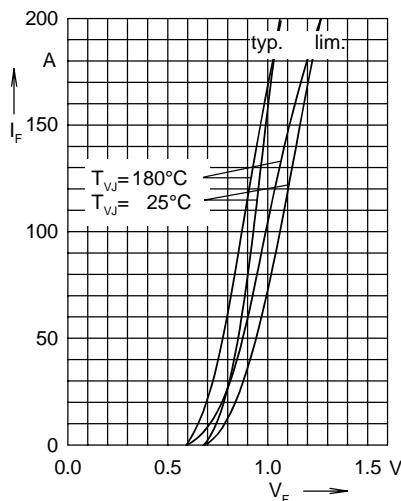


Fig. 1 Forward characteristics

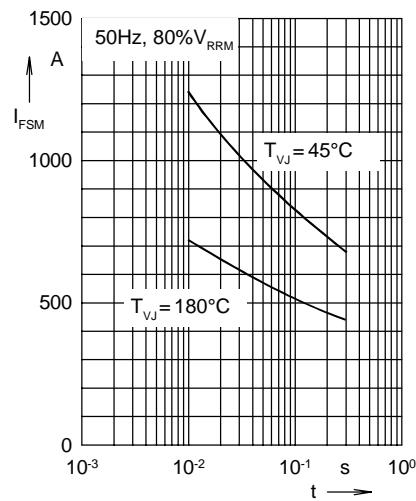


Fig. 2 Surge overload current
 I_{FSM} : crest value, t: duration

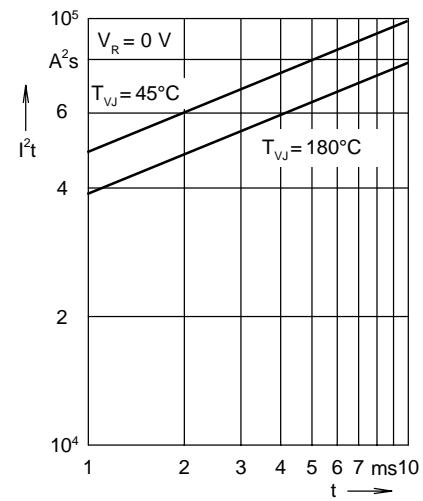


Fig. 3 I^2t versus time (1-10 ms)

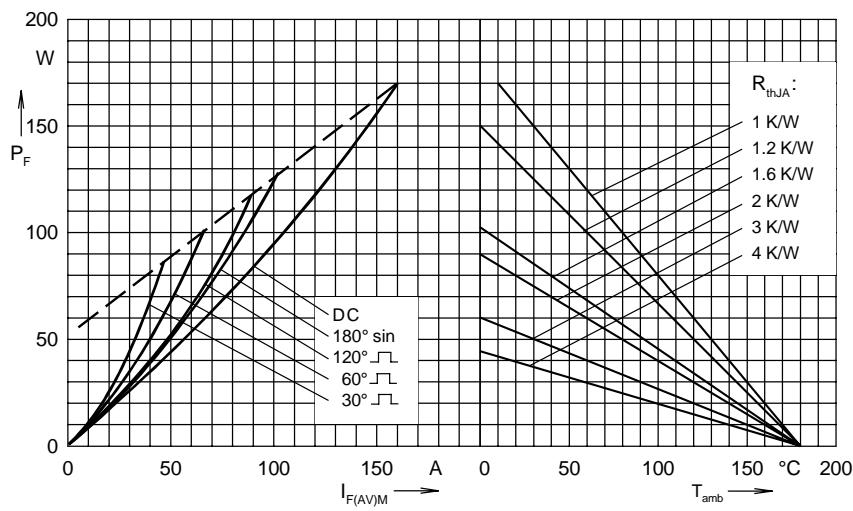


Fig. 4 Power dissipation versus forward current and ambient temperature

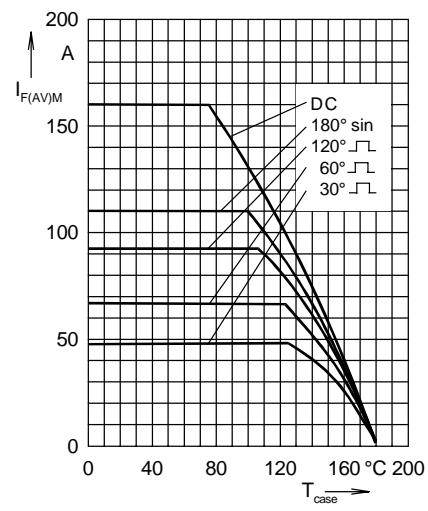


Fig. 5 Max. forward current at case temperature

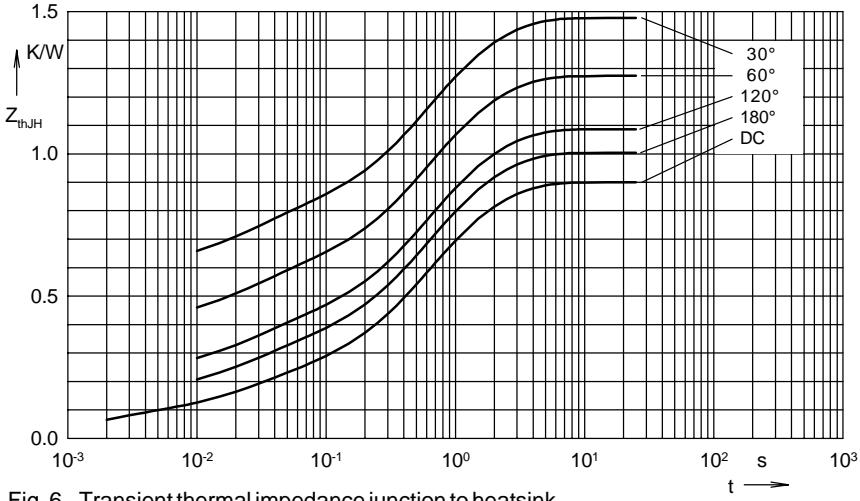


Fig. 6 Transient thermal impedance junction to heatsink

R_{thJH} for various conduction angles d:

d	R_{thJH} (K/W)
DC	0.900
180°	1.028
120°	1.085
60°	1.272
30°	1.476

Constants for Z_{thJH} calculation:

i	R_{thi} (K/W)	t_i (s)
1	0.0731	0.0015
2	0.1234	0.0237
3	0.4035	0.4838
4	0.3000	1.5